

IRFI9Z24N-VB Datasheet

P-Channel 60-V (D-S) MOSFET

PRODUC	T SUMMARY		
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ)
- 60	0.100 at V _{GS} = - 10 V	- 20	12.5
- 00	0.120 at V _{GS} = - 4.5 V	- 15	12.5

FEATURES

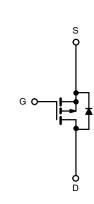
- Trench Power MOSFET
- 100 % UIS Tested

APPLICATIONS

Load Switch







P-Channel MOSFET

Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current ($T_1 = 175 ^{\circ}C$)	T _C = 25 °C	1_	- 20	
	T _C = 100 °C	- I _D	- 12	1
Pulsed Drain Current	·	I _{DM}	- 60	А
Continuing Source Current (Diode Conduction)		۱ _S	- 12	1
Avalanche Current		I _{AS}	- 12	1
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ
Maximum Power Dissinction	T _C = 25 °C	P-	30 ^a	w
Maximum Power Dissipation	T _A = 25 °C	P _D	2 ^b	vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
hunstion to Ambient	$t \le 10 \text{ sec}$	R _{thJA}	20	25			
Junction-to-Ambient ^D	Steady State		62	75	°C/W		
Junction-to-Case		R _{thJC}	5	6			

Notes:

a. See SOA curve for voltage derating.

b. Surface Mounted on 1" x 1" FR-4 boad.

SPECIFICATIONS $T_J = 25$	°C, unless	otherwise noted					
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static	•	· · · · ·			•		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 60			v	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 1.0	- 2.0	- 3.0	v	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μΑ	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50		
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 ^{\circ}\text{C}$			- 150		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			А	
		V _{GS} = - 10 V, I _D = - 5 A		0.100			
	-	V_{GS} = - 10 V, I_{D} = - 5 A, T_{J} = 125 °C		0.150			
Drain-Source On-State Resistance ^b	r _{DS(on)}	V_{GS} = - 10 V, I_{D} = - 5 A, T_{J} = 175 °C		0.200		Ω	
		V _{GS} = - 4.5 V, I _D = - 2 A		0.120			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic	•	•		*	•		
Input Capacitance	C _{iss}			550		pF	
Output Capacitance	C _{oss}	V _{DS} = - 25 V, V _{GS} = 0 V, f = 1 MHz		95			
Reverse Transfer Capacitance	C _{rss}			60			
Total Gate Charge	Qg			12.5	19	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -30$ V, $V_{GS} = -10$ V, $I_{D} = -8.4$ A		2.3			
Gate-Drain Charge	Q _{gd}			3.2		1	
Gate Resistance	R _g	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10	-	
Rise Time ^c	t _r	V_{DD} = - 30 V, R_{L} = 3.57 Ω		14	25		
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ - 8.4 A, V_GEN = - 10 V, R_G = 2.5 Ω		15	25	ns	
Fall Time ^c	t _f			7	12		
Source-Drain Diode Ratings and Cha	aracteristics	(T _C = 25 °C) ^b					
Pulsed Current	I _{SM}				- 20	А	
Forward Voltage ^b	V _{SD}	$I_{F} = -2 \text{ A}, V_{GS} = 0 \text{ V}$		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}	I _F = - 8 A, di/dt = 100 A/μs		50	80	ns	
Reverse Recovery Time	Q _{rr}	$r_{\rm F} = -6$ A, $u/u_{\rm I} = 100$ A/ μ S		80	120	nC	

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

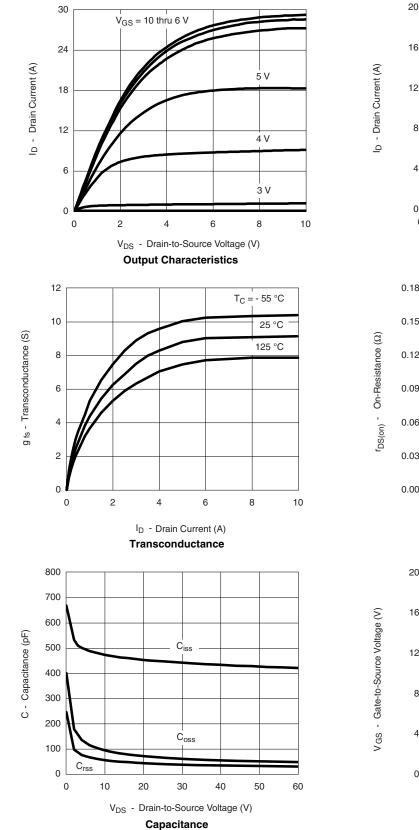
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

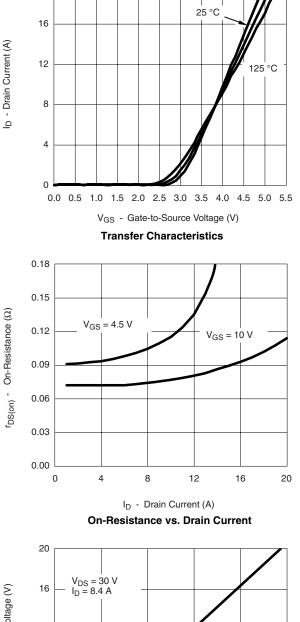
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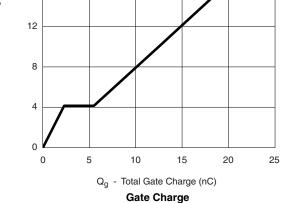


T_C = - 55 °C

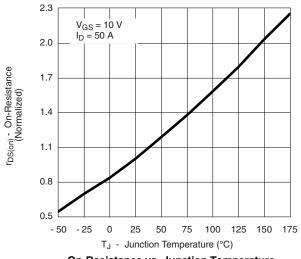


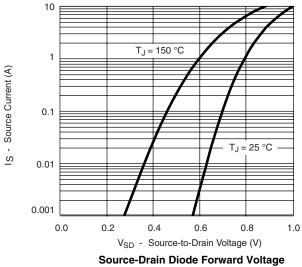
TYPICAL CHARACTERISTICS 25 °C unless noted





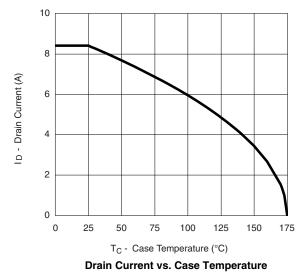
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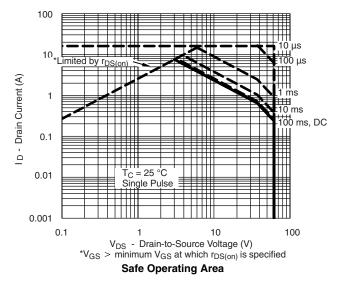




On-Resistance vs. Junction Temperature

THERMAL RATINGS



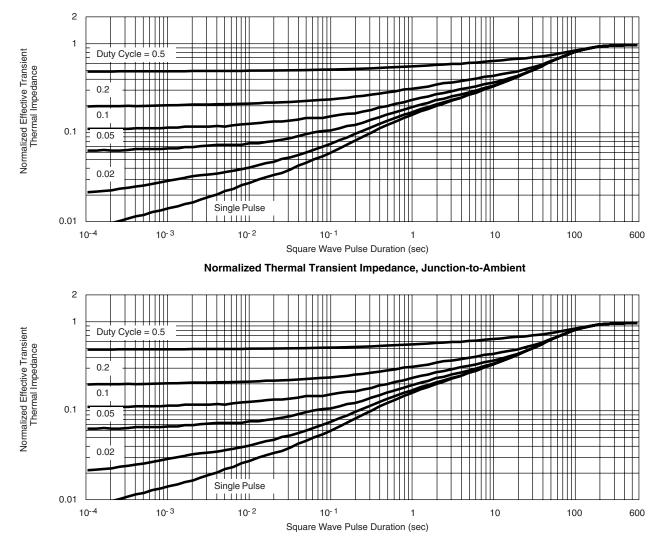


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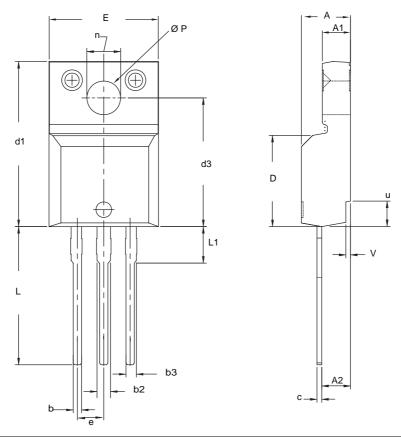
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK



DIM.	MILL	MILLIMETERS	MILLIMETERS		HES
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100) BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

DWG: 5972

Notes

1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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